ROCHESTER INSTITUTE OF TECHNOLOGY MICROELECTRONIC ENGINEERING

Fluid Channels for Evaluation of MEMS Pumps and Gas Flow Sensors

Dr. Lynn Fuller, George Manos, Suyana Villarroel Webpage: http://www.rit.edu/~lffeee

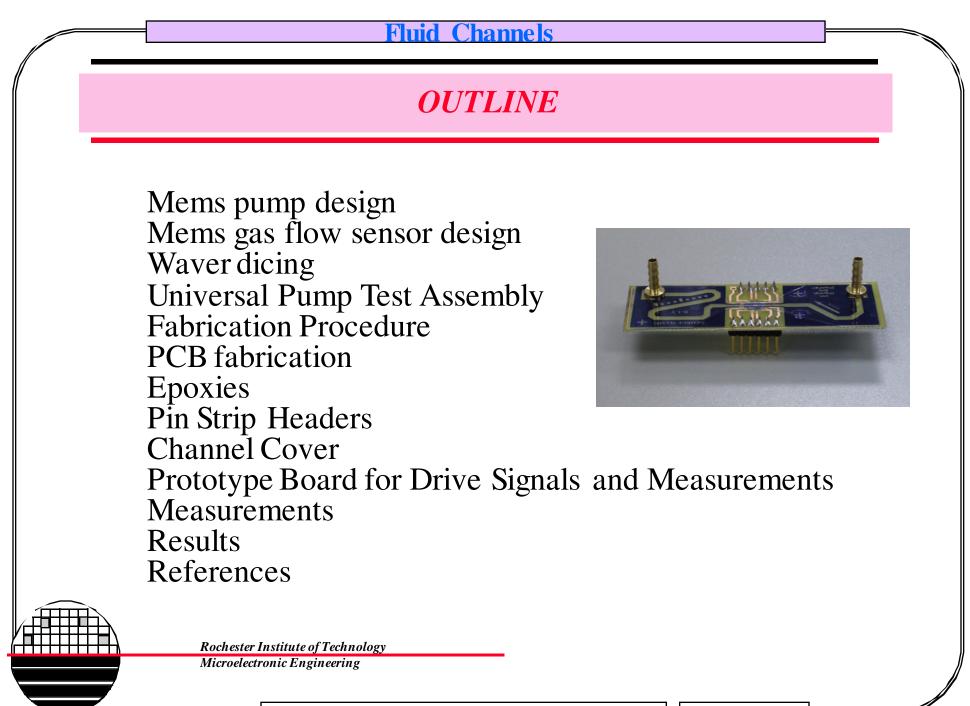
Microelectronic Engineering Rochester Institute of Technology 82 Lomb Memorial Drive Rochester, NY 14623-5604 Tel (585) 475-2035 Fax (585) 475-5041 Email: LFFEEE@rit.edu Department webpage: http://www.microe.rit.edu

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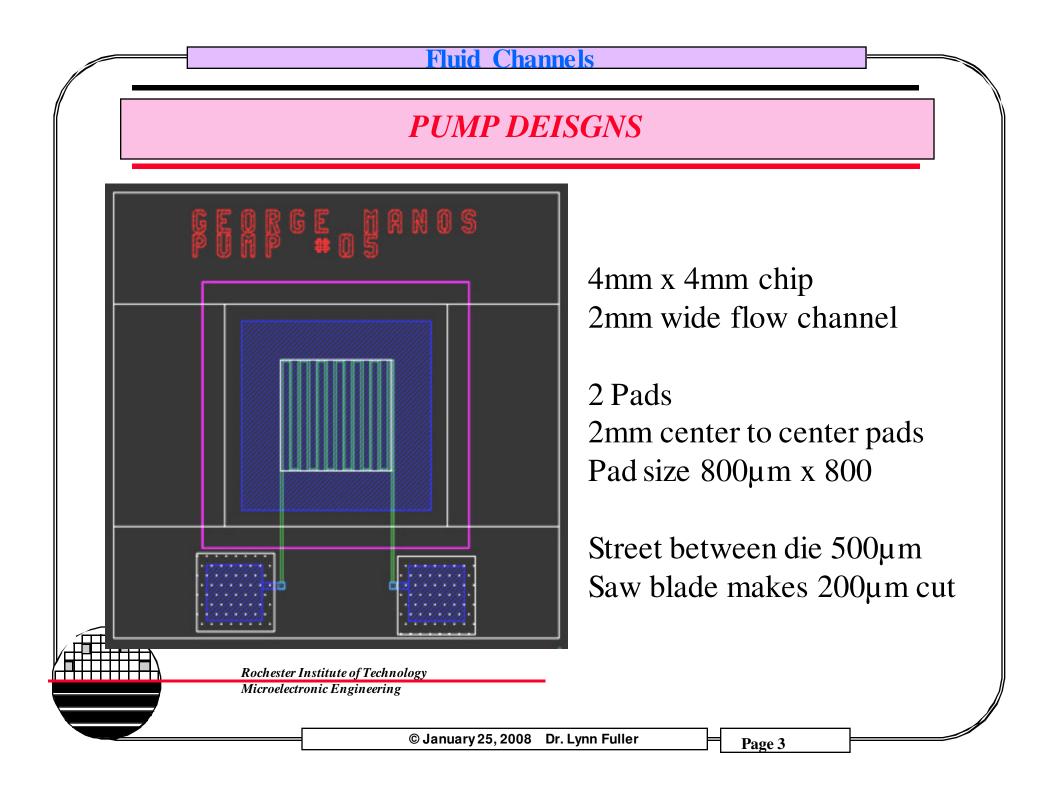
Microelectronic Engineering

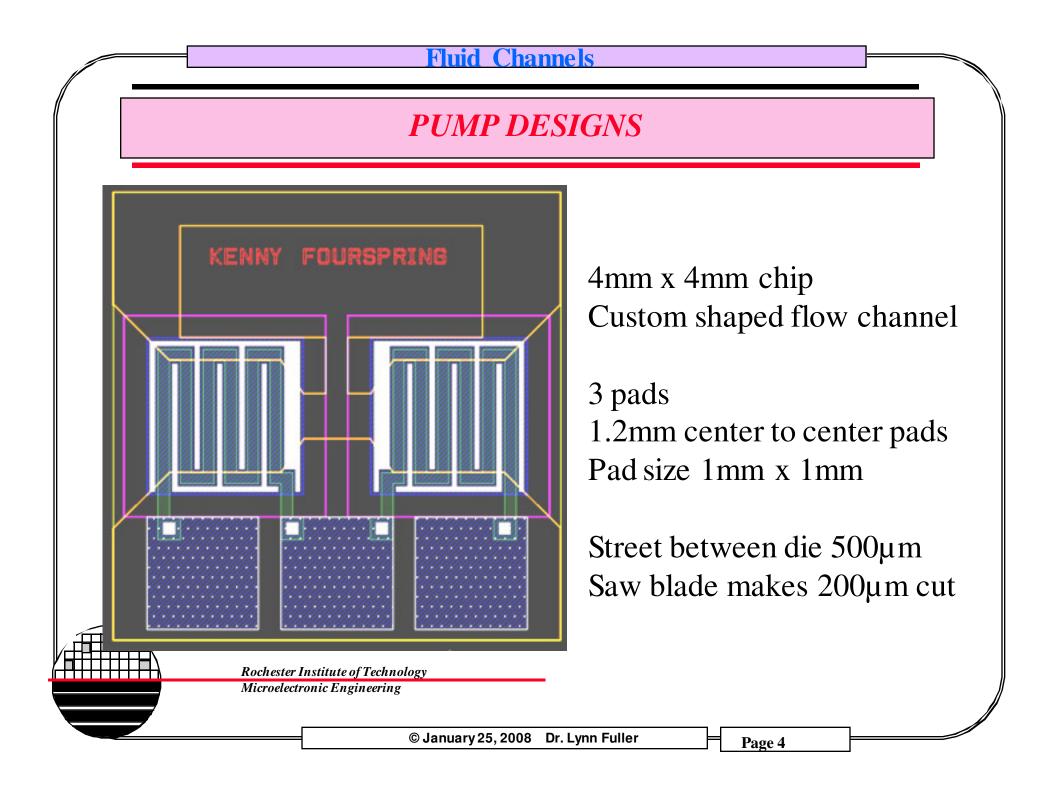
1-25-2008 Fluid_Channels.ppt

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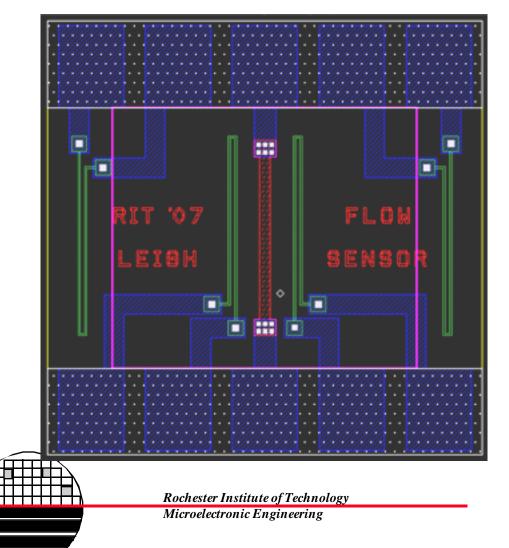


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GAS FLOW SENSOR DESIGN



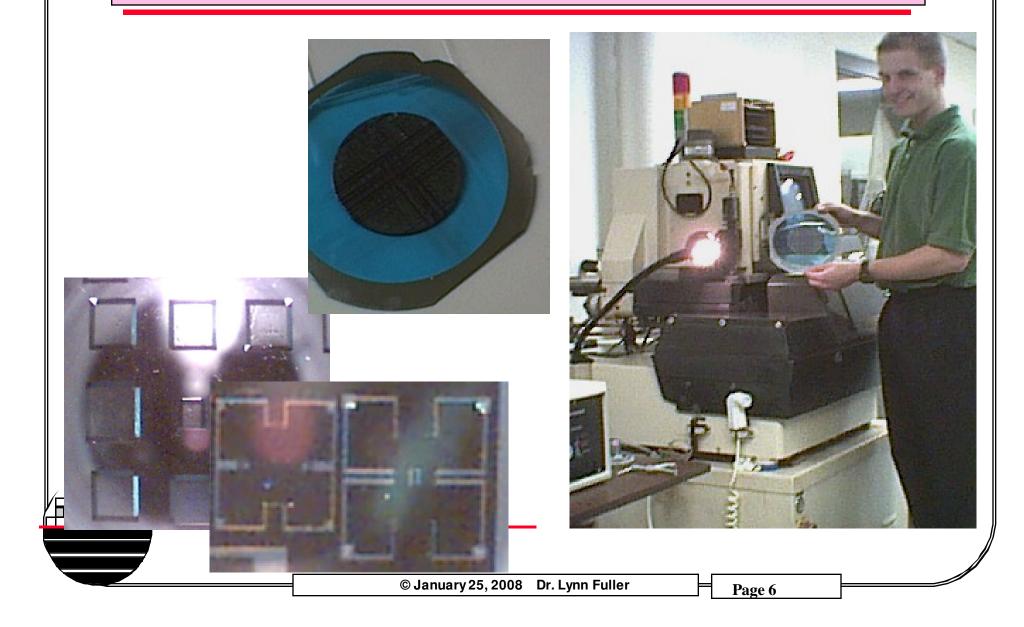
4mm x 4mm chip 2mm wide flow channel

10 pads 800μm center to center pads Pad size 600μm x 600μm

Street between die 500µm Saw blade makes 200µm cut

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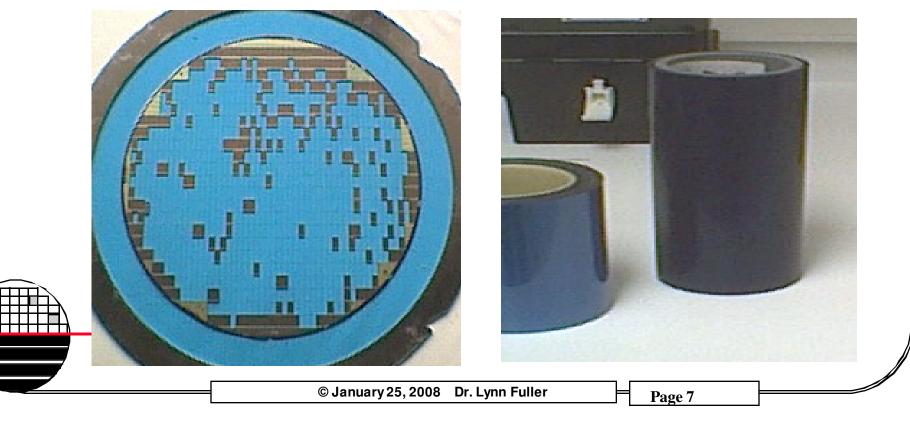
K&S 780 WAFER SAW

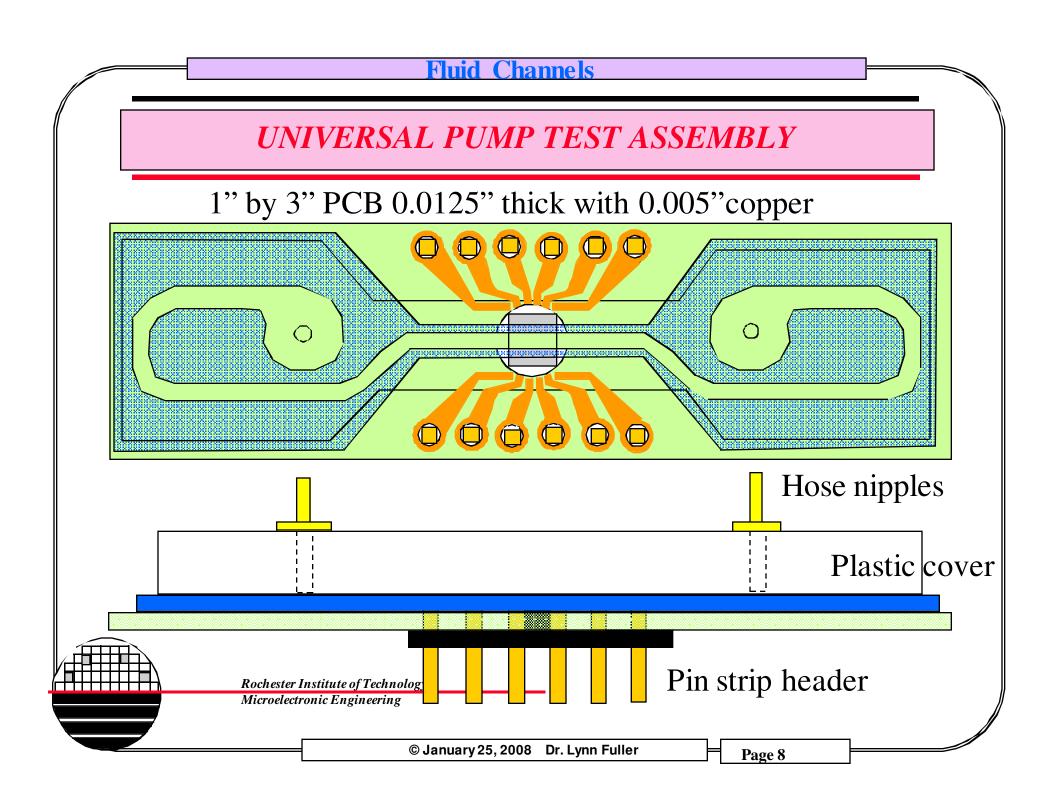


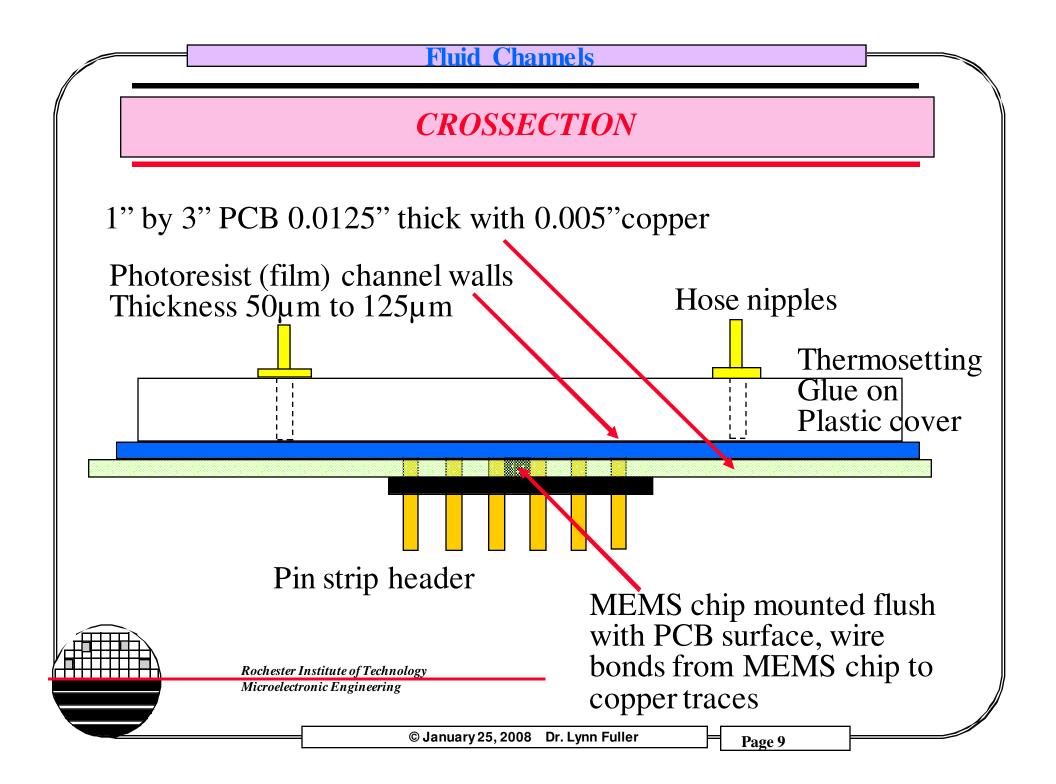
TAPES FOR DICING

Nitto Denko Corporation (http://www.nitto.com) Lintec Corp., Tokyo, Japan

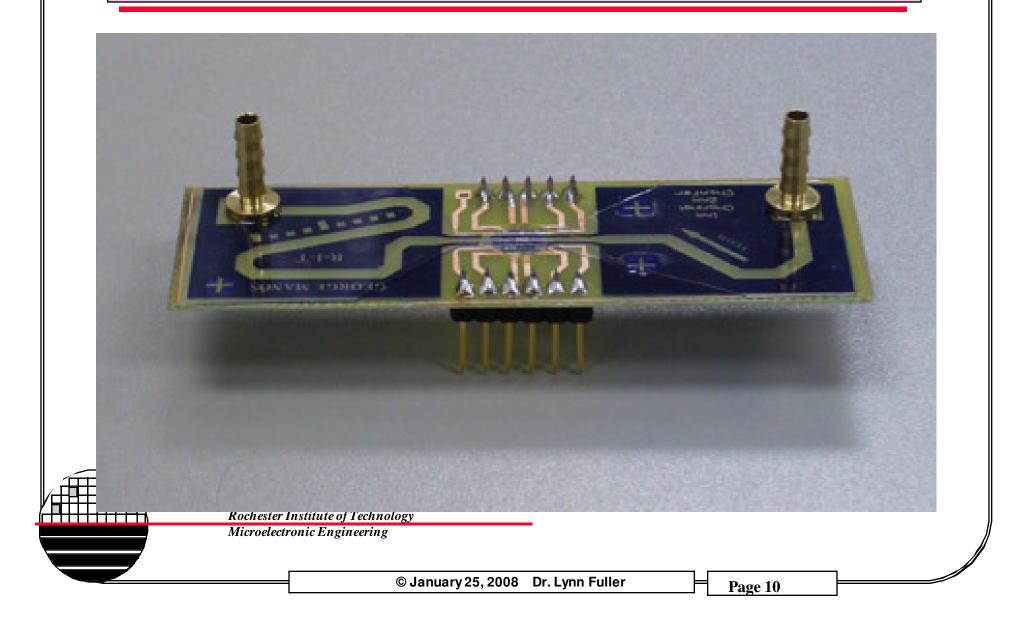
UV Light Release ADWILL T-5782, 200 mm x 10 m roll Extra Sticky, ADWILL G-19, 200 mm x 10 m roll

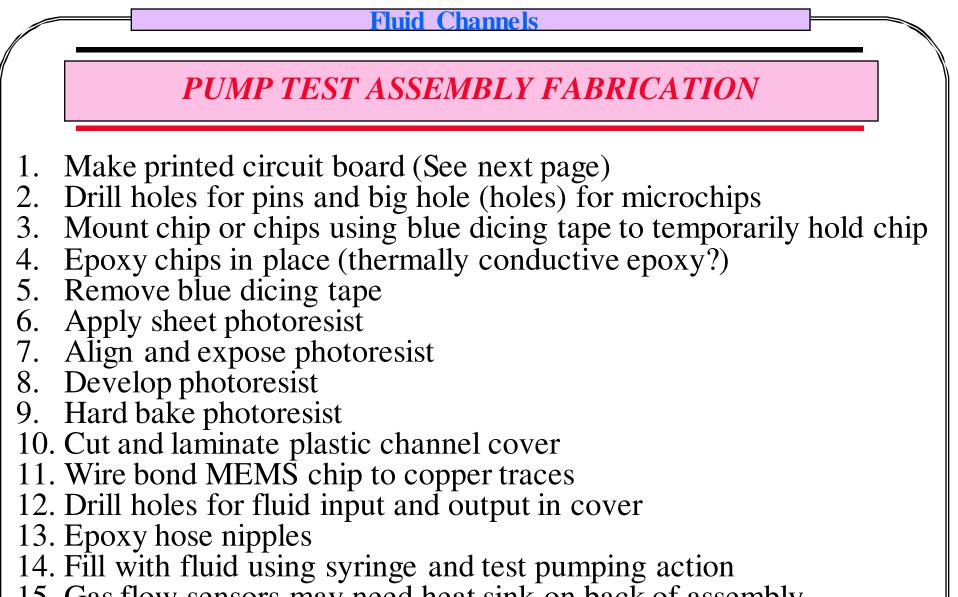






AFTER WIRE BONDS, HEADER AND NIPPLES





15. Gas flow sensors may need heat sink on back of assembly

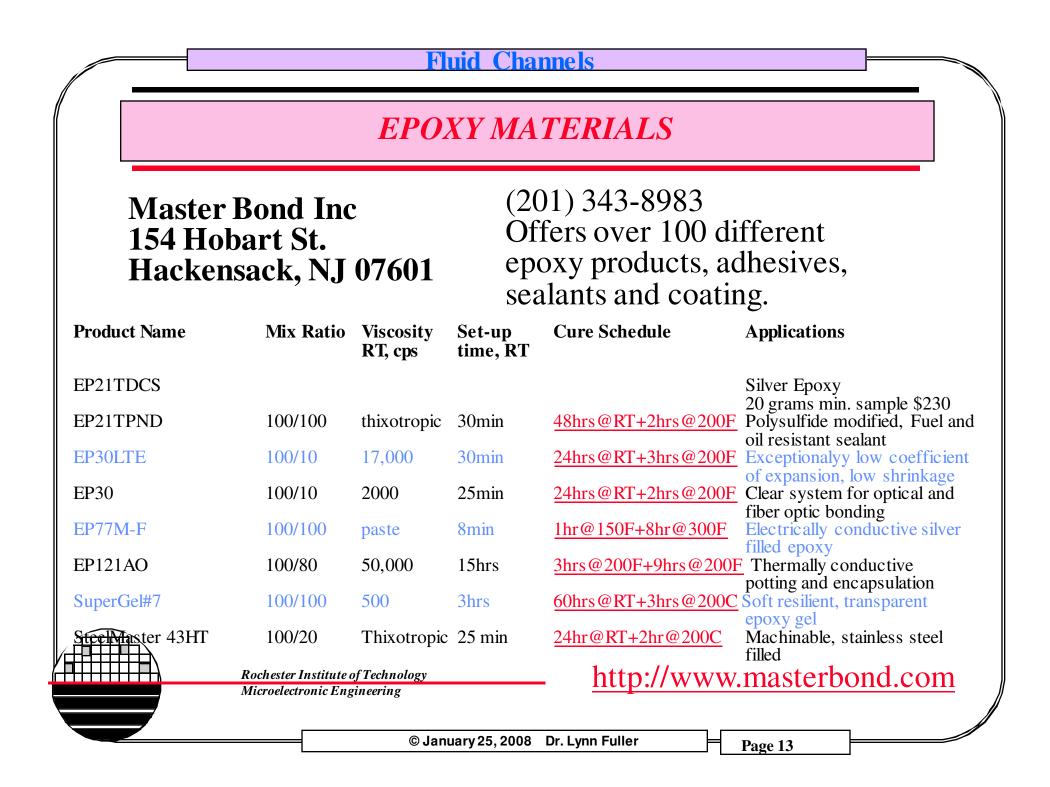
MAKE COPPER BOARD

Clean Board with 400 grit sand paper or very fine steel wool using Soap, Water and Blow Dry Spin Coat with Positive Photoresist (S1813), 1500 rpm Bake in Oven 100C 15 min. Place Transparency on Board and Flatten with Glass Plate Flood Expose, (10 sec = ~ 100 mj/cm2)Develop in CD-26 Developer (~1 min, overdevelop to ensure clear) Bake in Oven 140C 15 min Etch in Mixture of Water, H2O2, HCl (3:2:1) Strip Resist in Acetone, Rinse in Water Drill

Cut Board into Individual Packages Using Shear in Machine Shop

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PHOTOSENSITIVE FILMS



http://www.rayzist.com/

SR3000™ Self-Stick Resist - Sheets				"SELF-ADHESIVE REDEFINED"		
Thickness	595 sq in	5 Sheets 8.5" x 14"	1190 sq in	10 Sheets 8.5" x 14"	2975 sq in	25 Sheets 8.5" x 14"
3 mil	\$.063	\$37.49	\$.058	\$69.02	\$.053	\$157.68
4 mil	\$.068	\$40.46	\$.063	\$74.97	\$.058	\$172.55
5 mil	\$.073	\$43.44	\$.068	\$80.92	\$.063	\$187.43



Also ImageOn from RIT Bookstore 12"x10'x0.002" thick for \$18

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PC BOARD, ELECTROPLATE MOLD, SAND CARVING MASK

http://www.photobrasive.com PhotoBrasive Systems 4832 Grand Avenue Duluth, MN 55807 1-800-643-1037

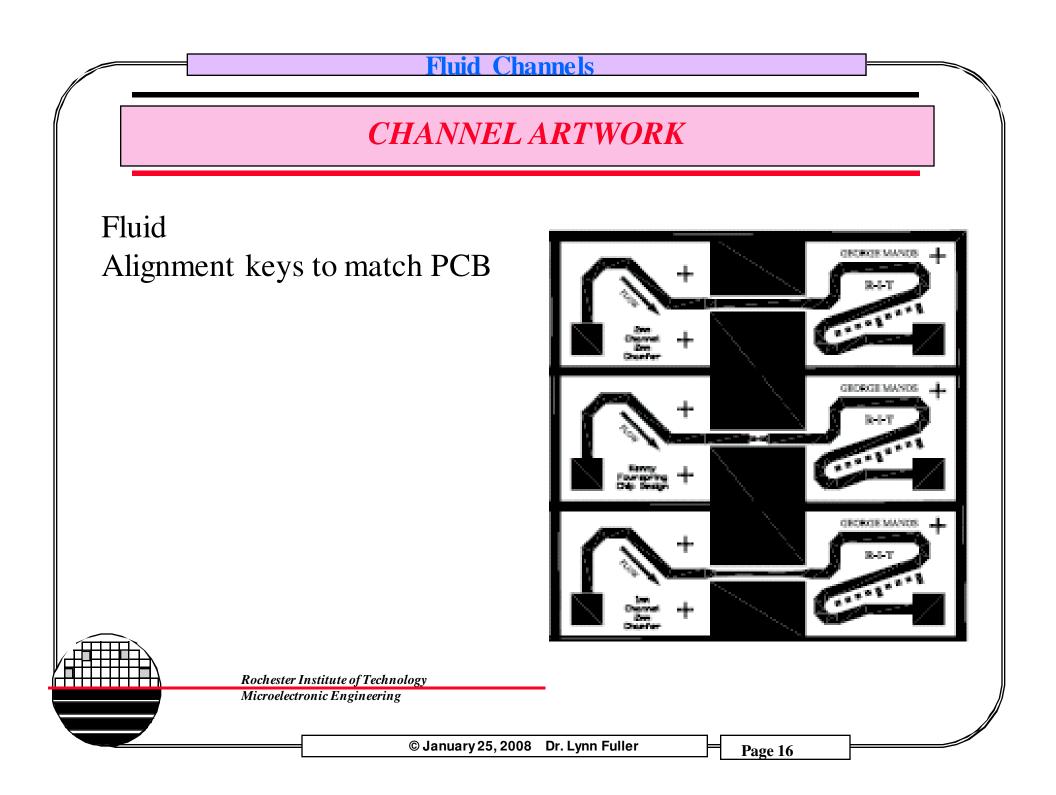
> Ultra Blue 10"x12" Qty 10 sheets 6 mil thick for \$98 Negative working resist, developed in water Self adhesive to substrate

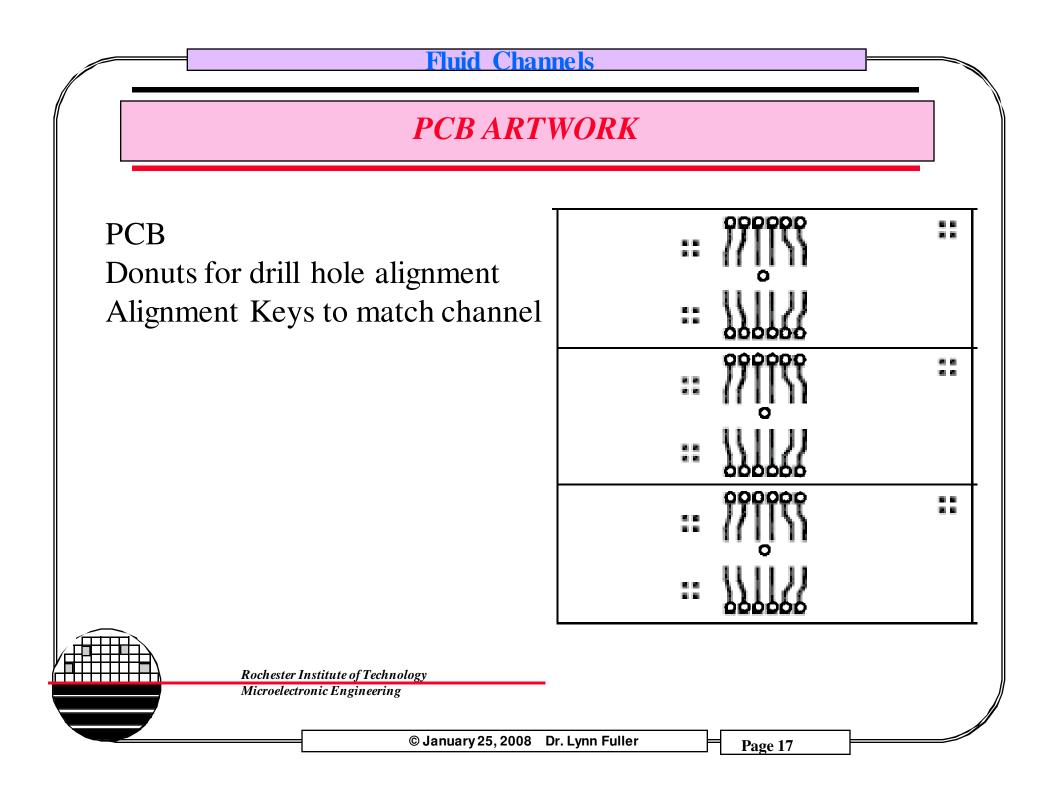
Also special waterproof films for inkjet printers 8.5" x 11" Qty 10 sheets for \$18

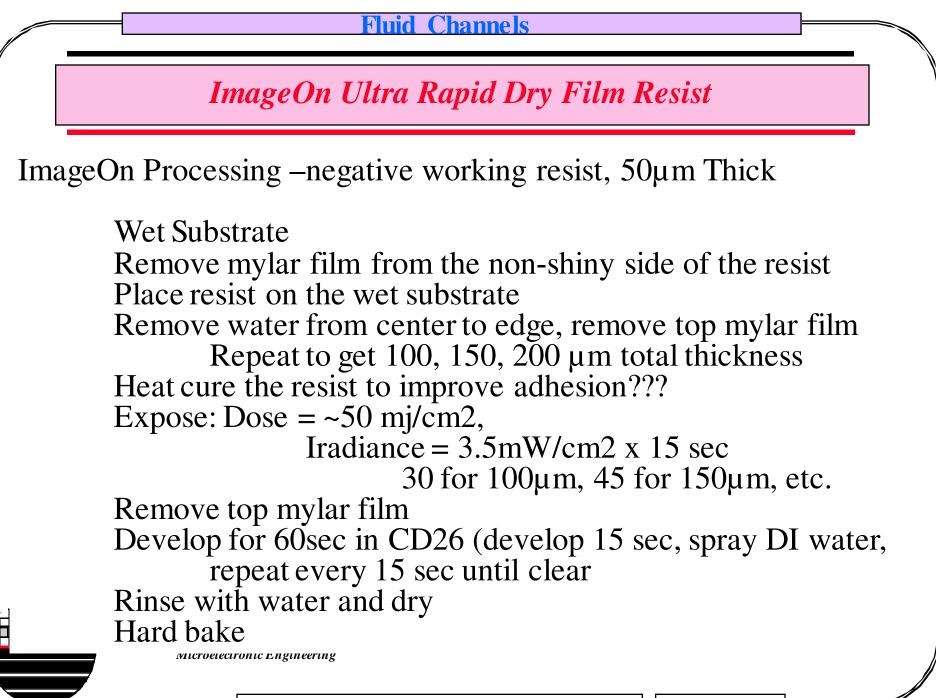
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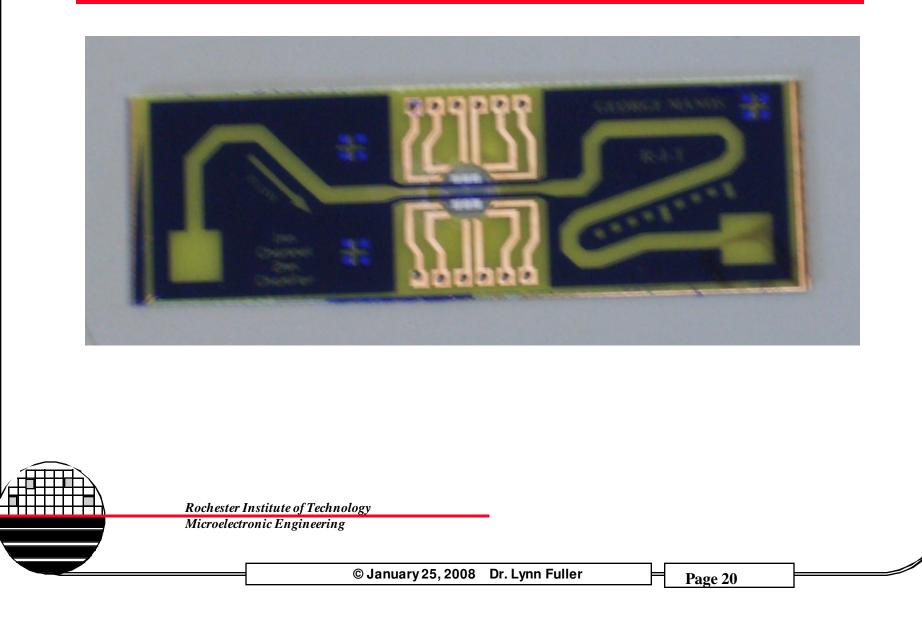


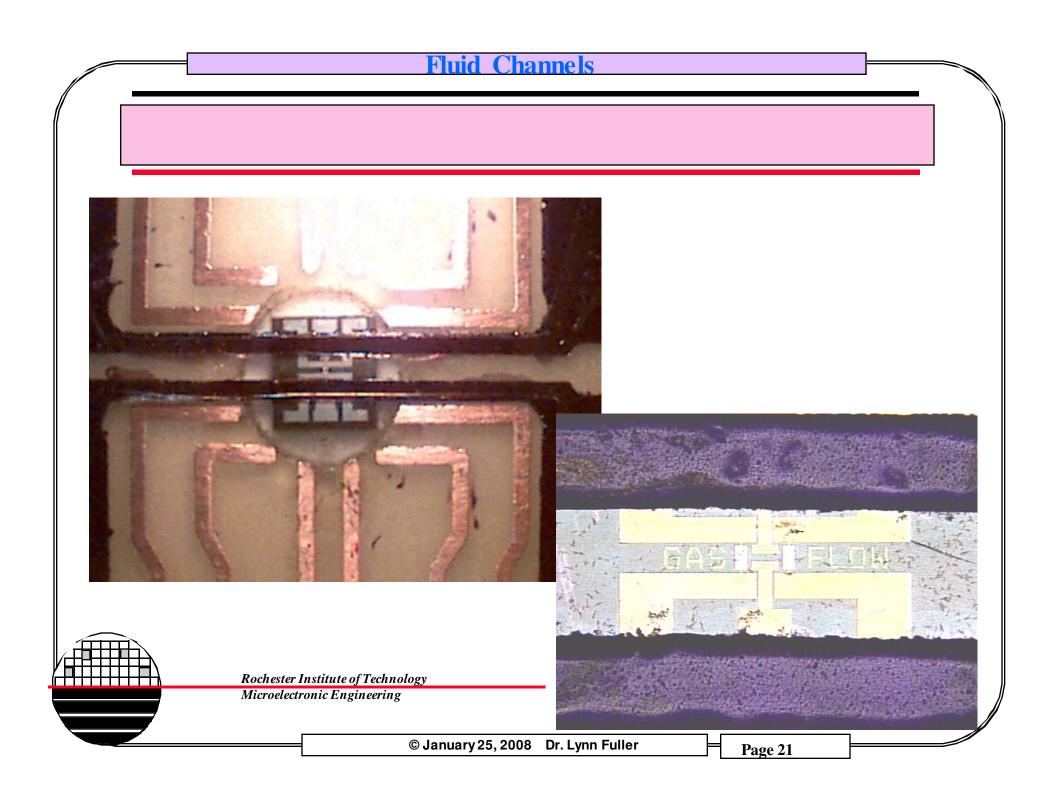


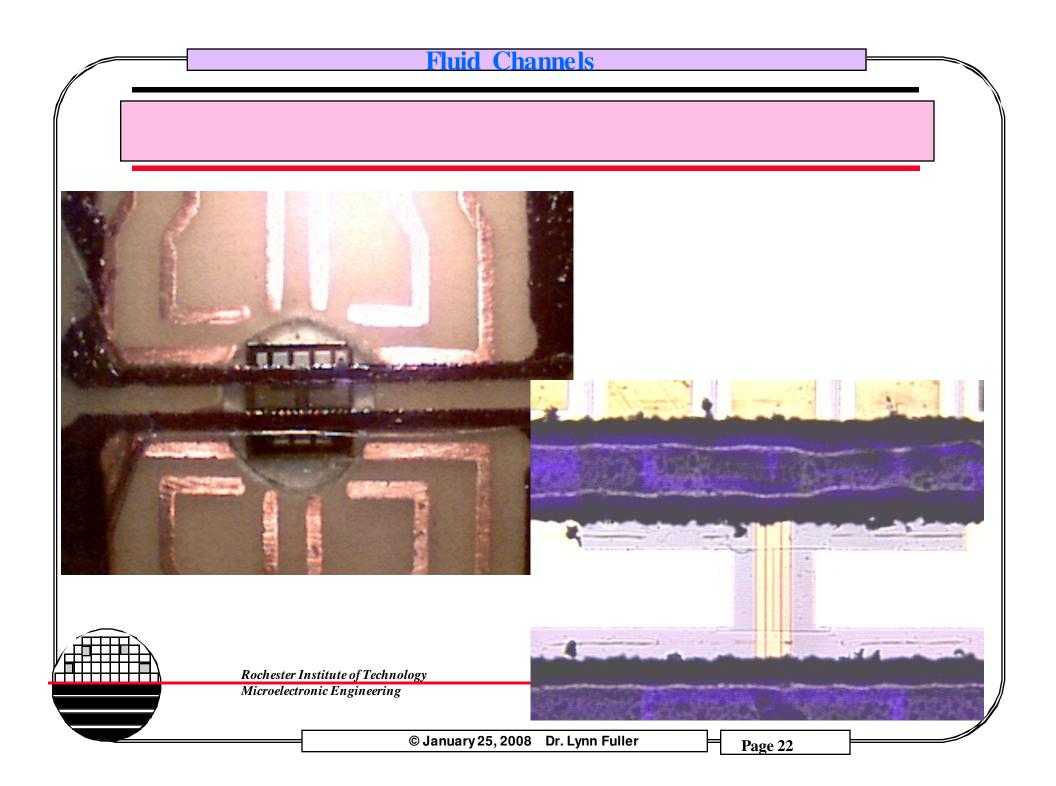


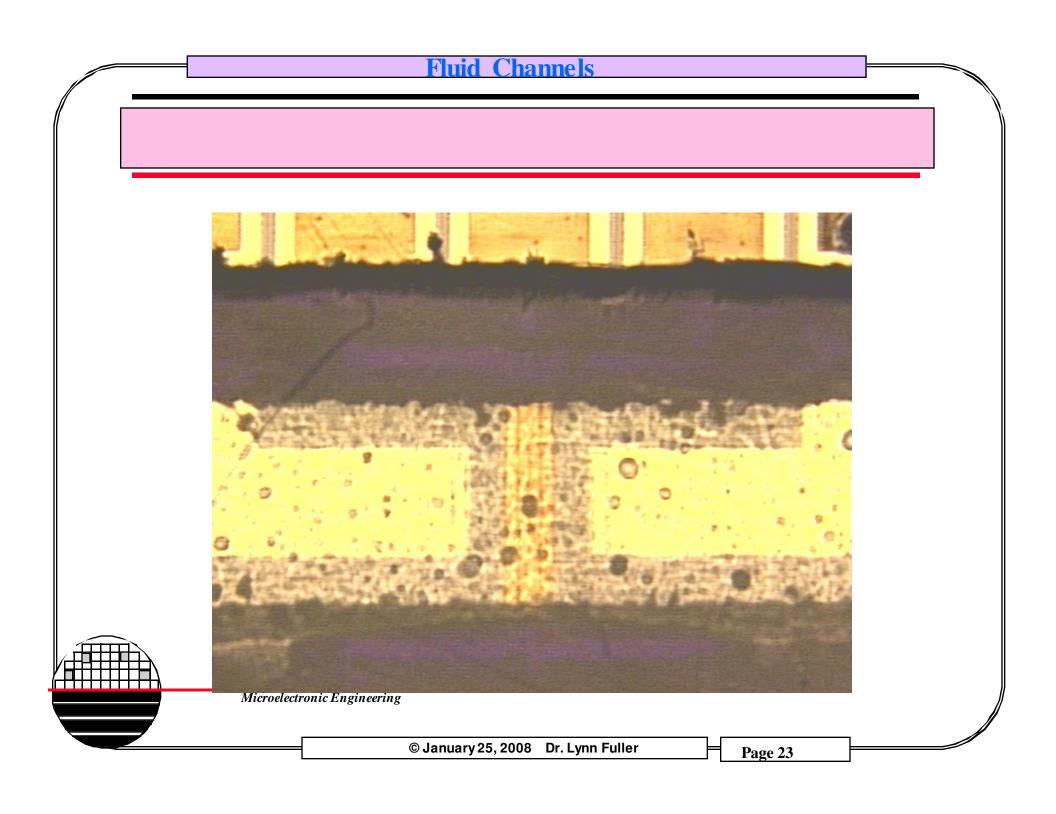
Fluid Channels **150µm DEEP CHANNELS** GEORGE MANON Relat 000010001 Rochester Institute of Technology Microelectronic Engineering © January 25, 2008 Dr. Lynn Fuller Page 19

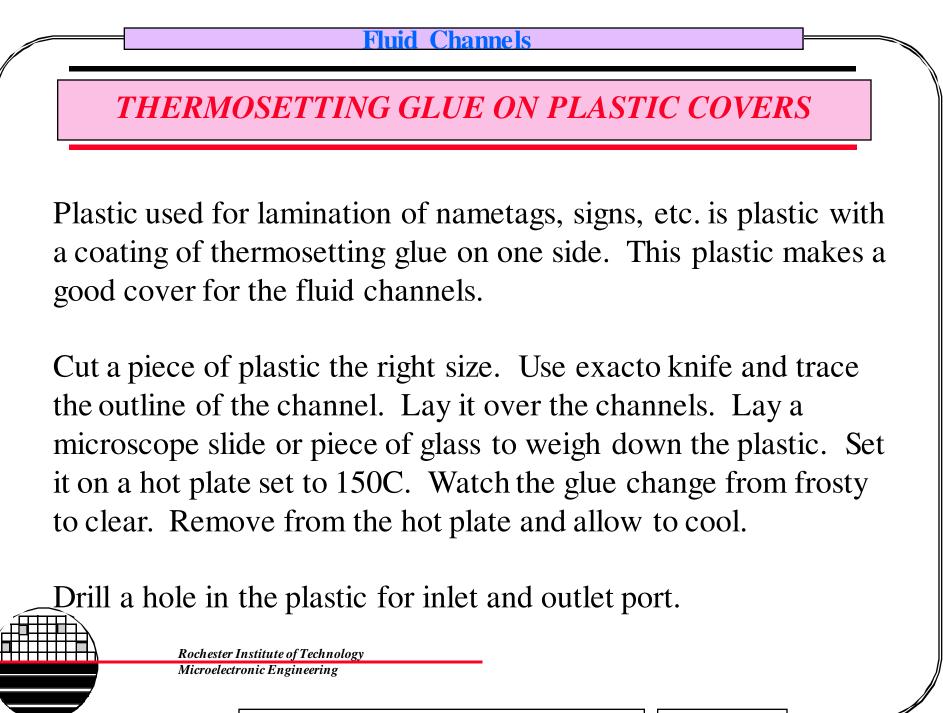
AFTER CHANNEL (NO TOP COVER) DEFINED

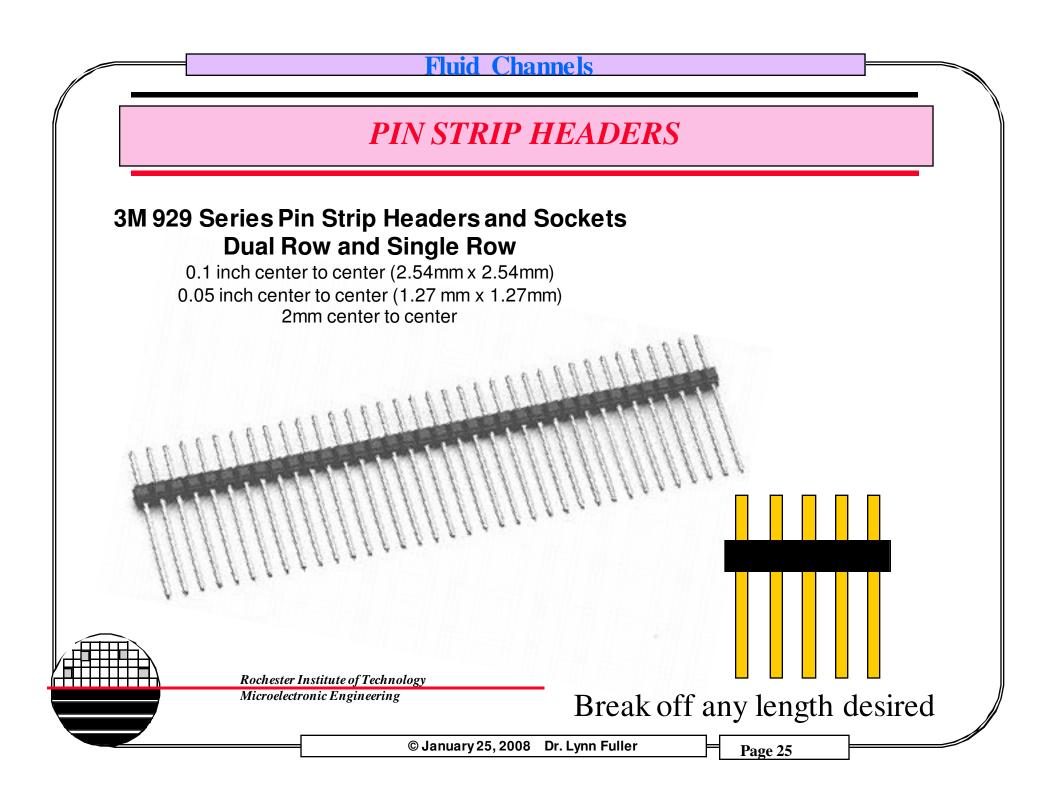












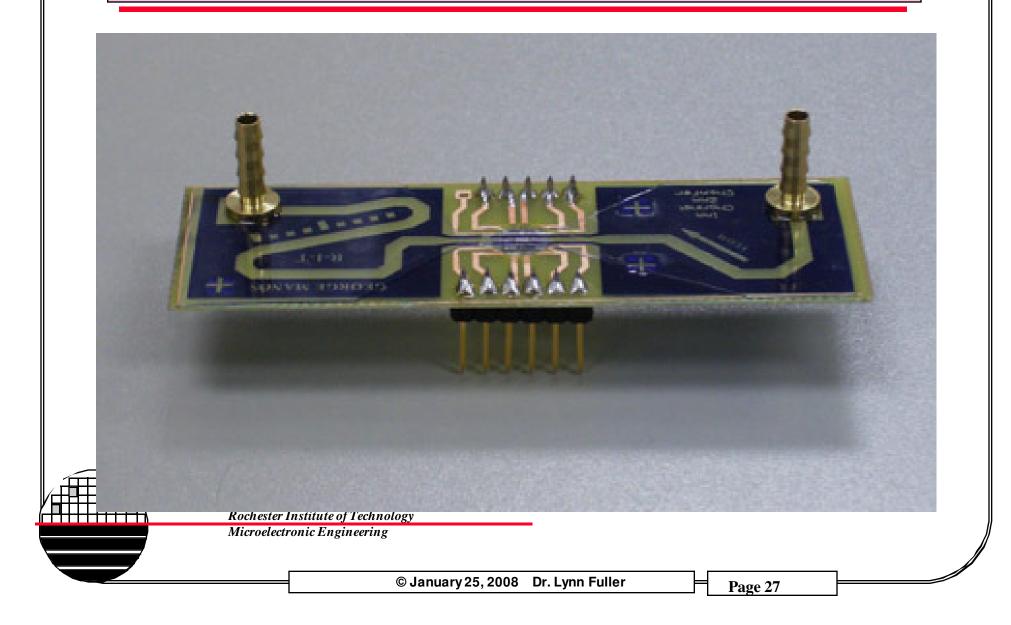
HOSE NIPPLES



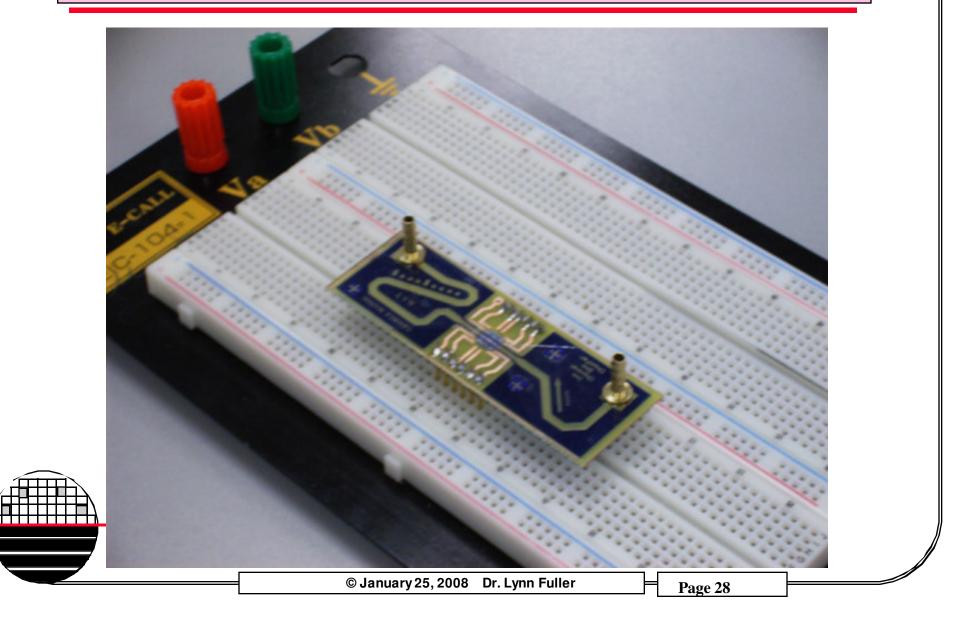
These are brass others are plastic and various sizes and shapes

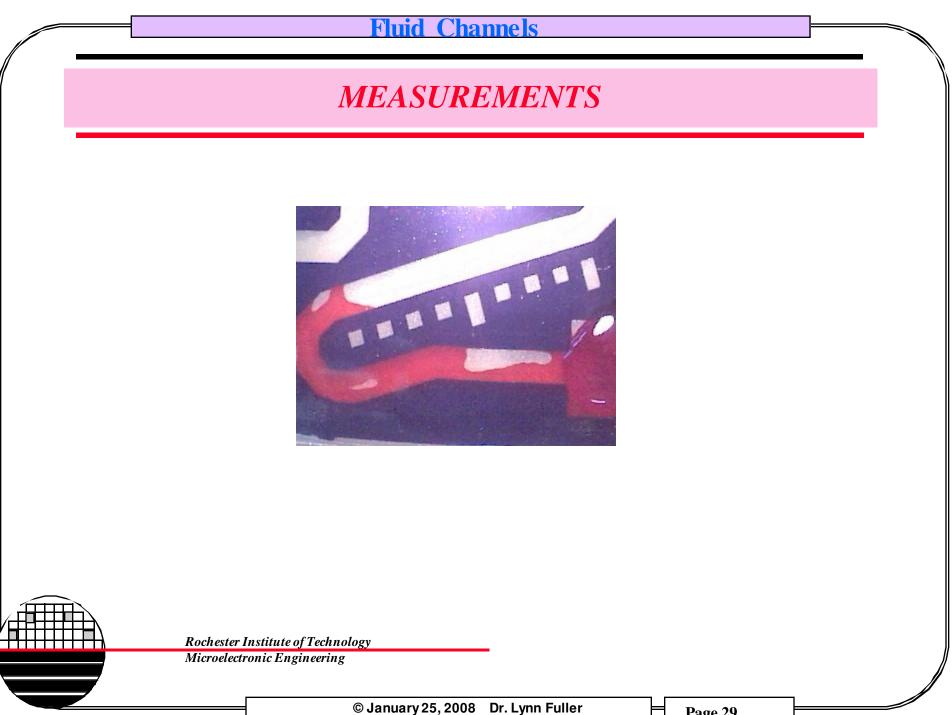
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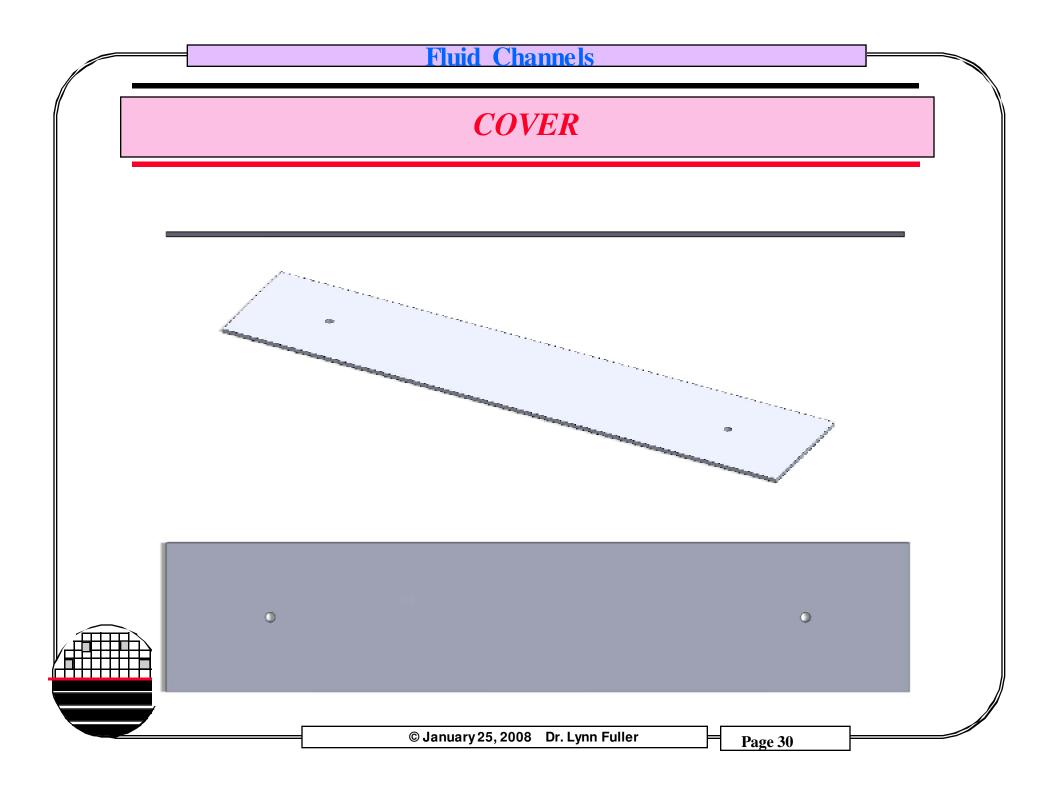
AFTER WIRE BONDS, HEADER AND NIPPLES

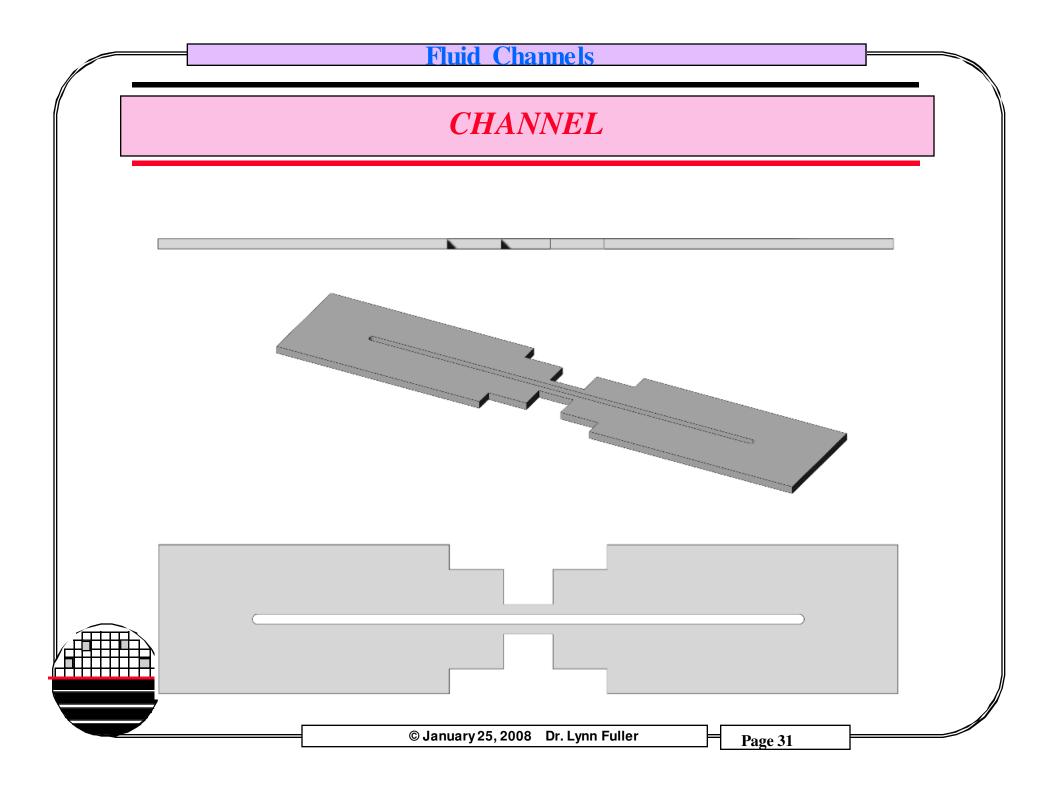


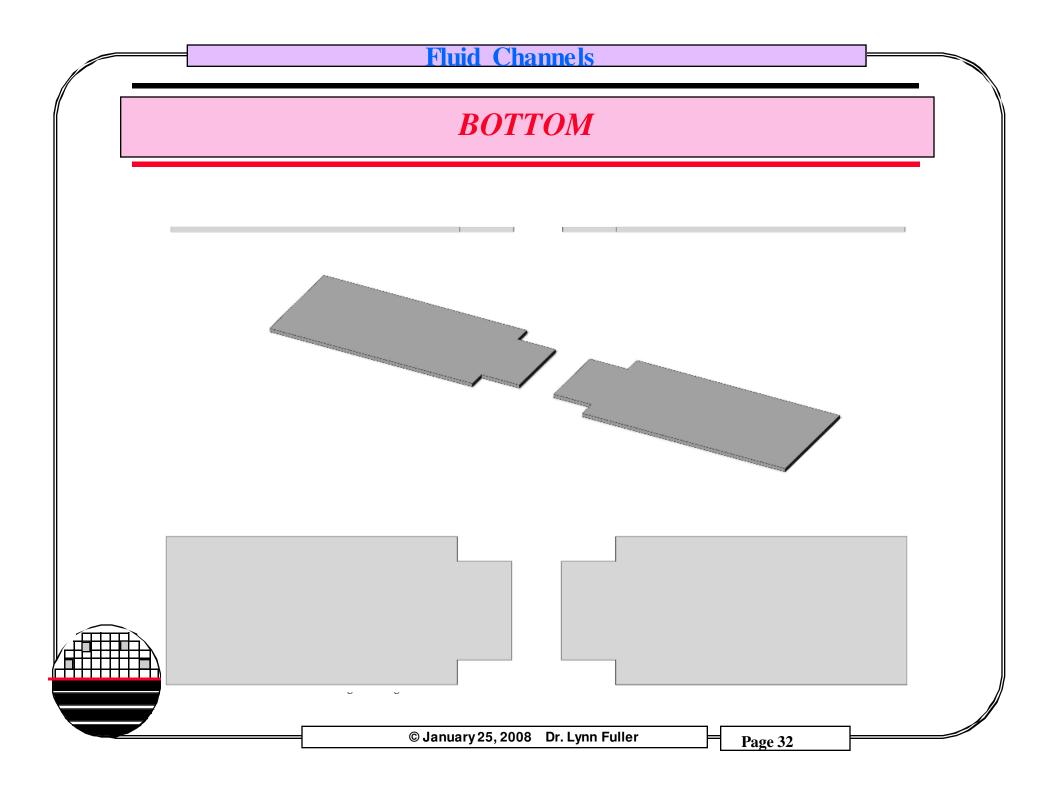
PROTOTYPE BOARD FOR DRIVE SIGNALS AND MEASUREMENTS

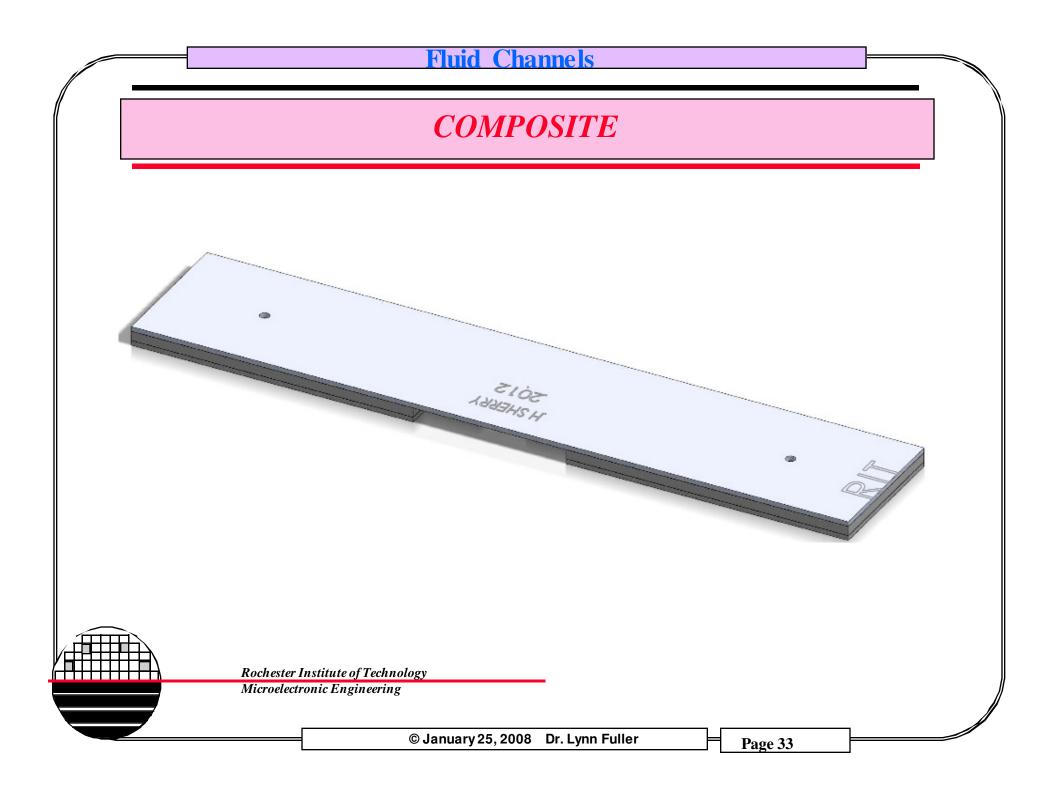


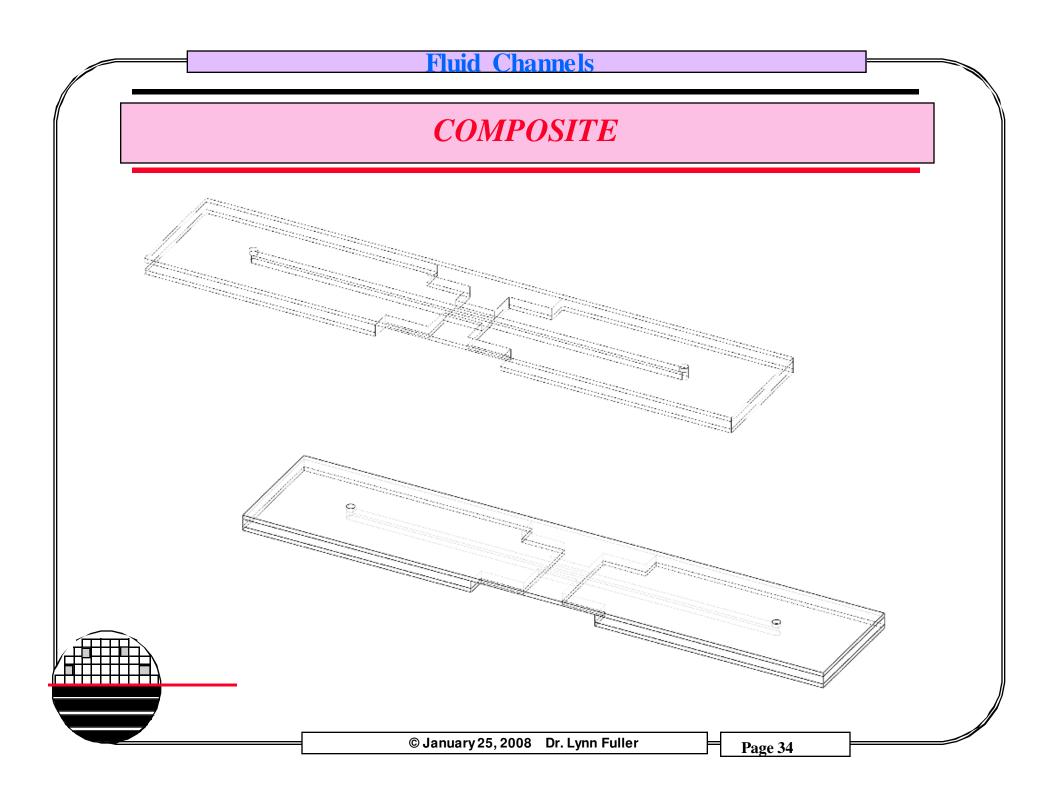












DIMENSION 3D PRINTER



Rochester Institute of Technology

Microelectronic Engineering



Dr. Denis Cormier Brinkman Lab at RIT © January 25, 2008 Dr. Lynn Fuller Page 35

DIMENSION 3D PRINTERS

HOME APPLICATIONS SUCCESS STORIES 3D PRINTERS COMPANY CONTACT FIND A RESELLER

DOWNLOADABLE WHITE PAPERS

Get the essential information on the uses and advantages of Dimension Printers in these concise reports:

How 3D Printing Fits into the Design Process

The Competitive Advantages of 3D Printing

Saving Time and Money with 3D Printing

Equipping Students with Design Tools

3D PRINTERS

FAQ (Frequently Asked Questions)

What is 3D Printing?

How does the Dimension process work?

Based on the patented Stratasys FDM® process, Dimension builds functional 3D models from the bottom up, one layer at a time with tough, durable acrylonitrile butadiene styrene (ABS) plastic.

STL files are imported into Catalyst® EX Software which automatically slices and orients the parts and creates any necessary support structures. The software automatically plots a precise deposition path for Dimension to follow. ABS plastic (in filament form within auto-loading cartridges) is fed into an extrusion head, heated to a semi-liquid state and accurately deposited in layers as fine as 0.007-inch (0.178 mm) thick. After completion of the build, support structures are simply removed.

ABS plastic is heated to a semi-liquid state and deposited in thin layers by a patented extrusion head.

Catalyst software automatically determines when and where to deposit ABS or support material throughout the build process.

How does 3D Printing fit into the design process?

- How durable is ABS?
- Are there any special facility requirements necessary to install a Dimension system?
- E Can more than one user process files and print parts on Dimension?
- Where can I see a Dimension system?
- What workstation operating system is required to run the system?

DIMENSION 3D PRINTERS ARE USED BY:

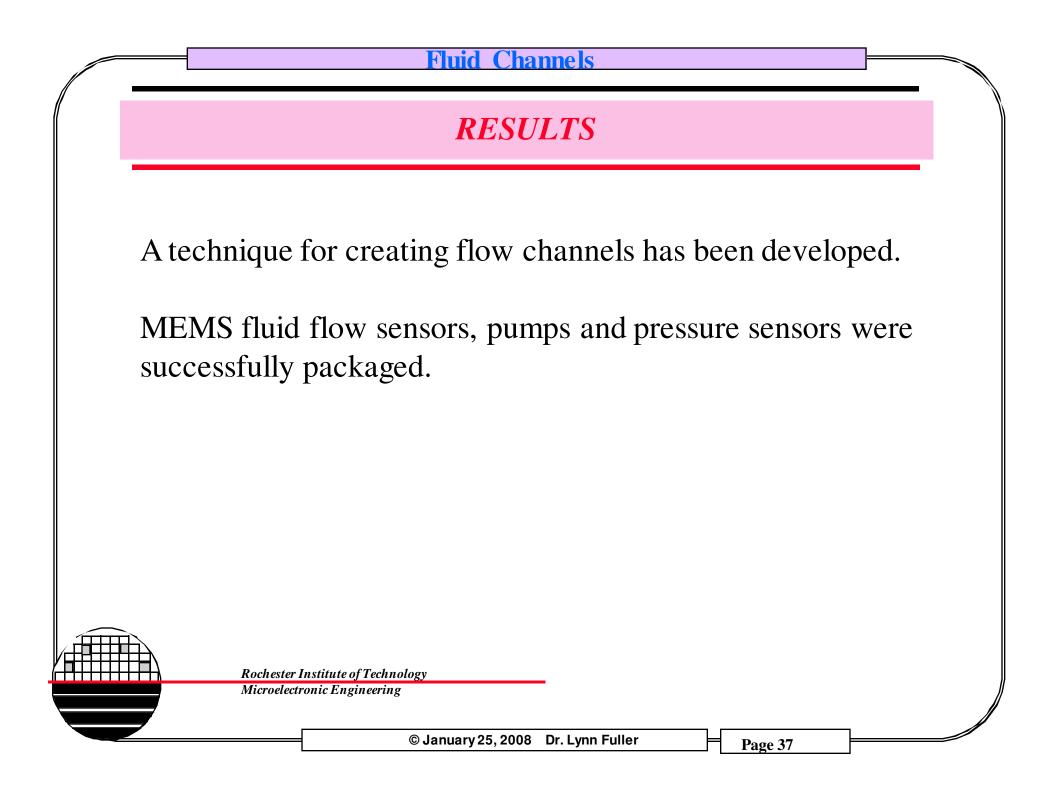
DURACELL

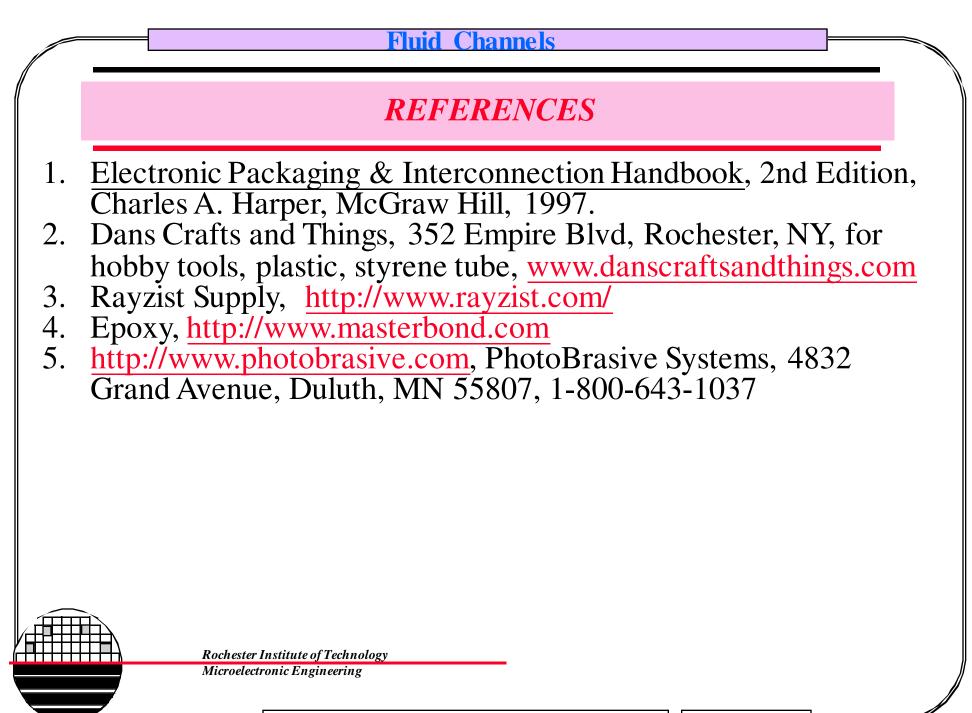
READY TO START PRINTING?

We can help you choose the Dimension 3D PRINTER that's right for you.

SITE SEARCH

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